MOSFETs Silicon N-channel MOS (U-MOSIV)

TPCA8085

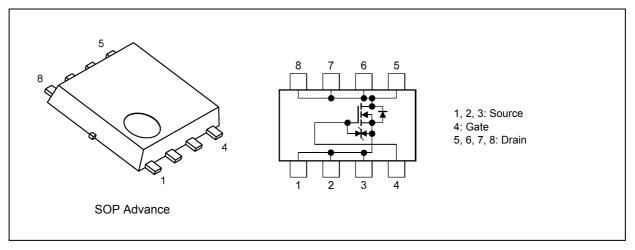
1. Applications

- Motor Drivers
- Switching Voltage Regulators

2. Features

- (1) Small, thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 4.6 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 10 \text{ V})$
- (3) Low leakage current: I_{DSS} = 10 μ A (max) (V_{DS} = 40 V)
- (4) Enhancement mode: V_{th} = 2.0 to 3.0 V (V_{DS} = 10 V, I_D = 1.0 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characte	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	40	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)		(Note 1)	I _D	40	A
Drain current (pulsed)		(Note 1)	I _{DP}	120	
Power dissipation	(T _c = 25°C)		PD	55	W
Power dissipation	(t = 10 s)	(Note 2)	PD	3.3	W
Power dissipation	(t = 10 s)	(Note 3)	PD	1.9	W
Single-pulse avalanche energy		(Note 4)	E _{AS}	92	mJ
Avalanche current			I _{AR}	40	A
Channel temperature		(Note 5)	T _{ch}	175	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 2012-10 2014-01-17 Rev.4.0

5. Thermal Characteristics

Characteristics				Max	Unit
Channel-to-case thermal resistance	(T _c = 25°C)		R _{th(ch-c)}	2.71	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R _{th(ch-a)}	44.6	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	78.1	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

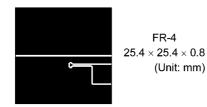
Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

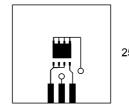
Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 60 μ H, R_G = 25 Ω , I_{AR} = 40 A

Note 5: Merely channel temperature is guaranteed 175°C.

Storage temperature range is guaranteed as usual (-55 to 150°C).





FR-4 25.4 × 25.4 × 0.8 (Unit: mm)

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a) Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

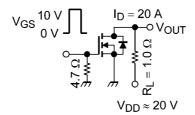
6. Electrical Characteristics

6.1. Static Characteristics (Ta = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V		_	±10	μA
Drain cut-off current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	40	_	_	V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	20	—	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1.0 mA	2.0	_	3.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 6 V, I _D = 20 A		6.5	10.4	mΩ
		V _{GS} = 10 V, I _D = 20 A	_	4.6	5.7	

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		2050	_	pF
Reverse transfer capacitance	C _{rss}			250	_	
Output capacitance	C _{oss}]		410	_	
Switching time (rise time)	tr	See Figure 6.2.1.	_	7	_	ns
Switching time (turn-on time)	t _{on}]		19	_	
Switching time (fall time)	t _f]		12	_	
Switching time (turn-off time)	t _{off}]		39	_	



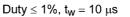


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

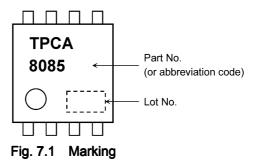
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 32$ V, V_{GS} = 10 V, I_D = 40 A	_	41	_	nC
Gate-source charge 1	Q _{gs1}		_	10	—	
Gate-drain charge	Q _{gd}		_	13	_	

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

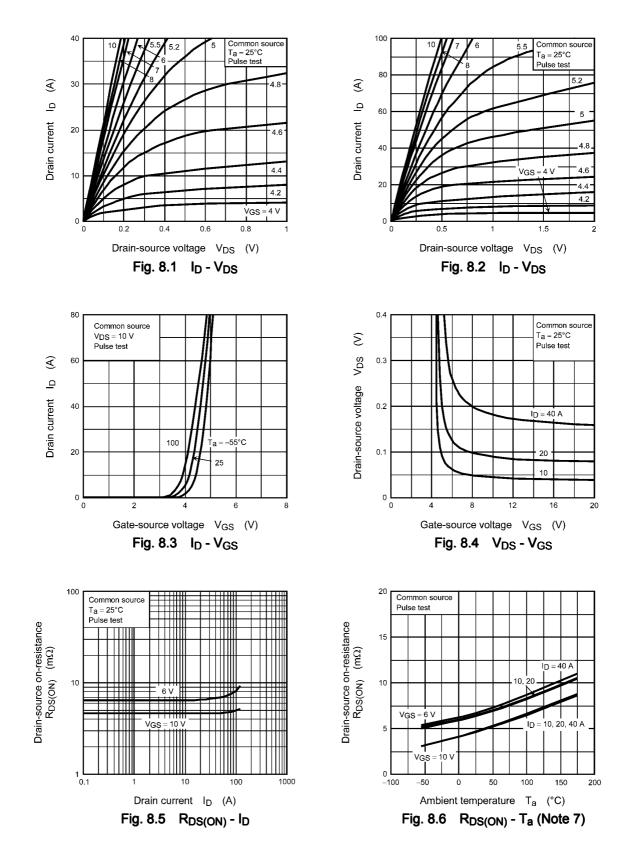
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 6)	I _{DRP}	—	_	_	120	А
Diode forward voltage	V _{DSF}	I _{DR} = 40 A, V _{GS} = 0 V	_	_	-1.2	V

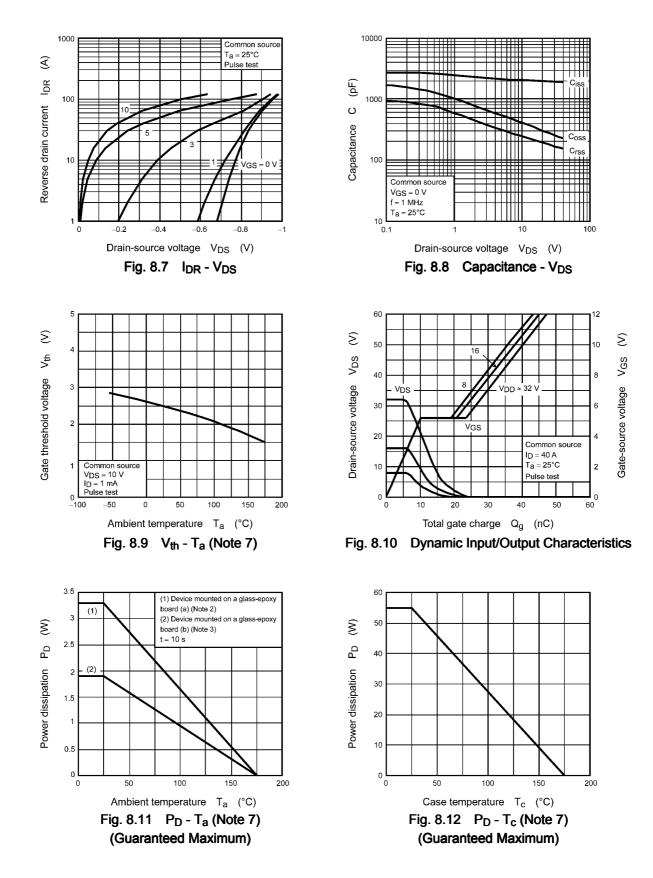
Note 6: Ensure that the channel temperature does not exceed 175°C.

7. Marking



8. Characteristics Curves (Note)

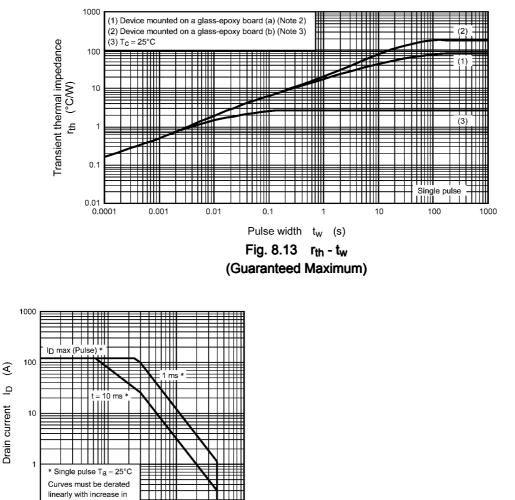


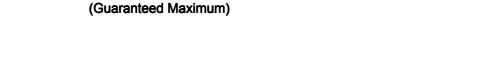




temperature.

0.1 **–** 0.1





100

VDSS

Drain-source voltage V_{DS} (V) Fig. 8.14 Safe Operating Area

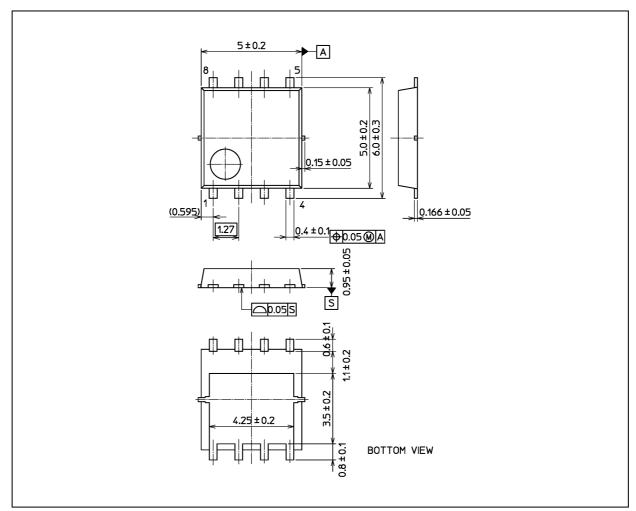
- Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.
- Note 7: Although several performance curves are shown up to a T_a or T_c of 175°C, the device is not guaranteed at storage temperatures up to 175°C. The storage temperature (T_{stg}) range is rated at -55°C to 150°C.



TPCA8085

Package Dimensions

Unit: mm



Weight: 0.069 g (typ.)

TOSHIBA: 2-5Q1S

Nickname: SOP Advance

Package Name(s)

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